



DMP1100UCB4

P-CHANNEL ENHANCEMENT MODE MOSFET

Product	Summary	✔ (Typ @V <sub>GS</sub>	= -4.5V, T <sub>A</sub> = -	+25°C)	
BV	Basian	0	0.	la.	1

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Qg	$Q_{gd}$	ID
-12V	65mΩ	9nC	2.4nC	-3.2A

## **Description and Applications**

This new generation MOSFET is designed to minimize the on-

state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications. It is a high-performance MOSFET in ultra-small 0.8mm x 0.8mm package.

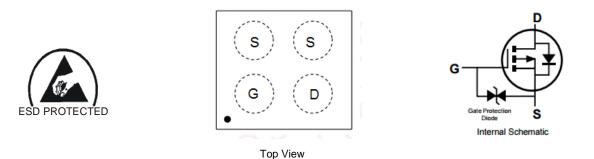
- Portable Applications
- Load Switch
- Power Management Functions

#### **Features and Benefits**

- Built-in G-S Protection Diode against ESD 2kV HBM
- Ultra Small 0.8mm x 0.8mm Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### Mechanical Data

- Case: X2-WLB0808-4
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- UBM Opening: 203µm



#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1100UCB4-7	X2-WLB0808-4	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



9W = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: D = 2016) M or  $\overline{M}$  = Month (ex: 9 = September)

Date Code Key

Notes:

Year	201	6	2017		2018	20	19	2020		2021	2	2022
Code	D		E		F	(	G	Н				J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	g	0	N	D



# **Maximum Ratings**

Characteristic		Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-12	V	
Gate-Source Voltage		V <sub>GSS</sub>	±8	V
Continuous Source Current @ $V_{GS}$ = -4.5V (Note 5)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-2.5 -2.0	А
Continuous Source Current @ $V_{GS} = -4.5V$ (Note 6)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-3.2 -2.6	А
Pulsed Drain Current (Pulse Duration 10µs, Duty Cycle ≤1%)		I <sub>DM</sub>	-13	А
Continuous Source-Drain Diode Current		Is	-1.2	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	0.67	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	187	°C/W
Total Power Dissipation (Note 6)	PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	117	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	-,					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-12	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	-1	μA	$V_{DS} = -12V, V_{GS} = 0V$
Gate-Body Leakage	Igss	-	-	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.35	-0.55	-0.8	V	$V_{DS} = V_{GS}, ID = -250 \mu A$
			65 80 90	83 96 150		$V_{GS} = -4.5V, I_D = -3A$ $V_{GS} = -2.5V, I_D = -2A$ $V_{GS} = -1.8V, I_D = -1A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	90 115 135 150	170 300 400	mΩ	$V_{GS} = -1.8V, I_D = -1A$ $V_{GS} = -1.5V, I_D = -1A$ $V_{GS} = -1.4V, I_D = -1A$ $V_{GS} = -1.3V, I_D = -1A$
Forward Transfer Admittance	Y <sub>fs</sub>	-	6.5	-	S	$V_{DS} = -4V, I_S = -1.5A$
Body Diode Forward Voltage	V <sub>SD</sub>	-	-0.7	-	V	$V_{GS} = 0V, I_S = -1.5A,$
DYNAMIC CHARACTERISTICS (Note 8)						·
Input Capacitance	Ciss	-	680	820	pF	$V_{DS} = -6V, V_{GS} = 0V,$
Output Capacitance	C <sub>oss</sub>	-	220	290	pF	$v_{DS} = -6V, v_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	-	205	280	pF	
Gate Resistance	R <sub>g</sub>	-	11.2	17	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	-	9.0	14	nC	
Gate-Source Charge	Q <sub>gs</sub>	-	1.0	-	nC	$V_{GS} = -4.5V, V_{DS} = -6V,$ $-I_{D} = -2A$
Gate-Drain Charge	Q <sub>gd</sub>	-	2.6	-	nC	-1D = -7W
Turn-On Delay Time	t <sub>D(ON)</sub>	-	4.4	9	ns	
Turn-On Rise Time	t <sub>R</sub>	-	10.1	-	ns	$V_{DD} = -4V, I_{D} = -2A$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	22	33	ns	$V_{\text{GEN}} = -4.5 \text{V}, \text{ R}_{\text{g}} = 1\Omega, \text{ R}_{\text{L}} = 3\Omega$
Turn-Off Fall Time	t <sub>F</sub>	-	20	-	ns	

Notes:

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.



# Electrical Characteristics (@T<sub>A</sub> = 0°C.)

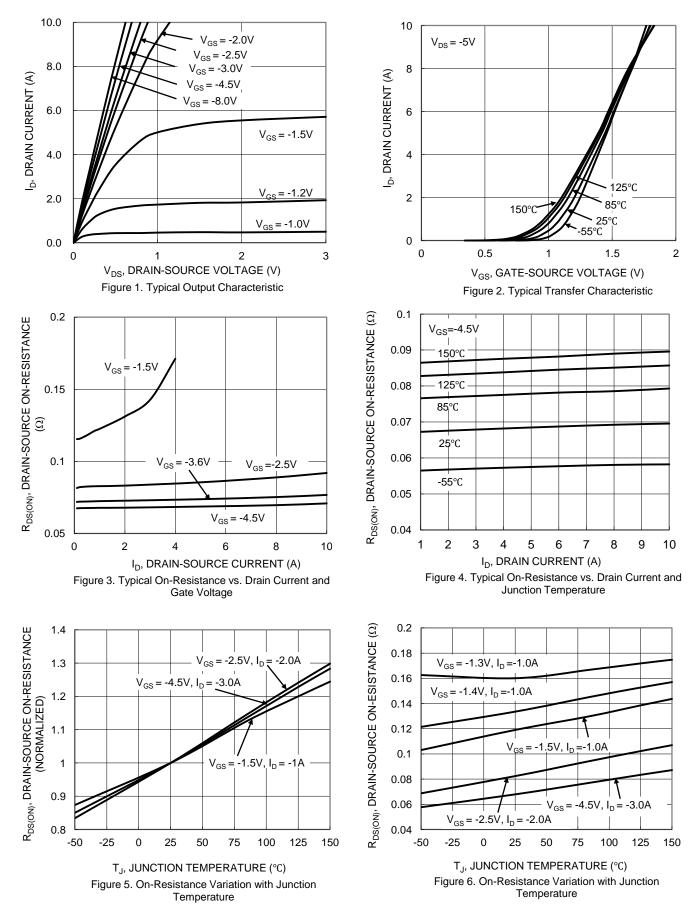
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
ON CHARACTERISTICS (Note 7,Note 8)						
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	62 78 88 112 130 150	83 96 150 170 300 400	mΩ	$ \begin{array}{l} V_{GS} = -4.5V, \ I_D = -3A \\ V_{GS} = -2.5V, \ I_D = -2A \\ V_{GS} = -1.8V, \ I_D = -1A \\ V_{GS} = -1.5V, \ I_D = -1A \\ V_{GS} = -1.4V, \ I_D = -1A \\ V_{GS} = -1.3V, \ I_D = -1A \end{array} $

# Electrical Characteristics (@T<sub>A</sub> = + 65°C.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
ON CHARACTERISTICS (Note 7,Note 8)						
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	73 89 107 127 141 163	93 118 185 195 300 400	mΩ	$ \begin{array}{l} V_{GS} = -4.5V, \ I_D = -3A \\ V_{GS} = -2.5V, \ I_D = -2A \\ V_{GS} = -1.8V, \ I_D = -1A \\ V_{GS} = -1.5V, \ I_D = -1A \\ V_{GS} = -1.4V, \ I_D = -1A \\ V_{GS} = -1.3V, \ I_D = -1A \end{array} $

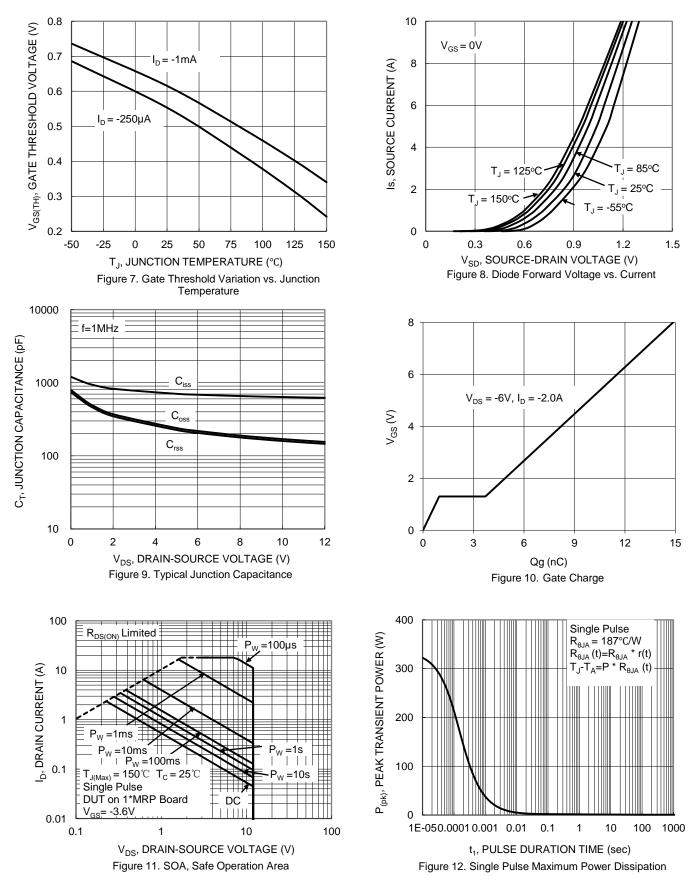
Note: 8. Guaranteed by design. Not subject to production testing.



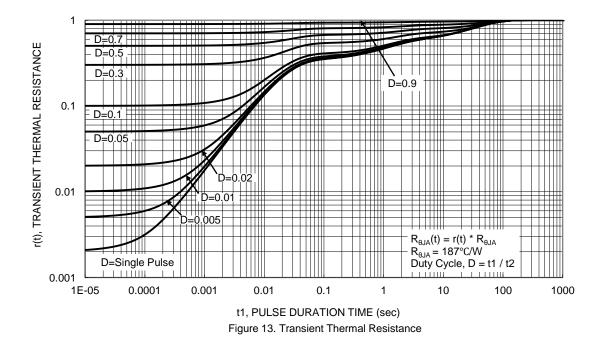




# DMP1100UCB4



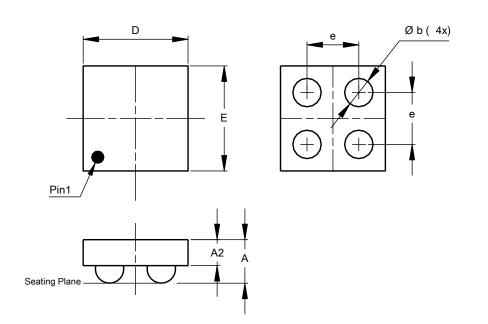






## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



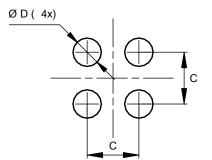
X2-WLB0808-4								
Dim	Min	Max	Тур					
Α		0.400	0.375					
A2			0.180					
b	0.1971	0.2409	0.219					
D	0.790	0.820	0.816					
Е	0.790	0.820	0.816					
е			0.400					
All	Dimens	sions in	mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-WLB0808-4

X2-WLB0808-4



Dimensions	Value (in mm)
С	0.400
D	0.219



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